

### STPS3L60-Y

### Automotive power Schottky rectifier

#### **Features**

- Negligible switching losses
- Low thermal resistance
- Avalanche capability specified
- AEC Q101 qualified
- ECOPACK<sup>®</sup>2 compliant component

#### **Description**

Schottky rectifier suited for switched mode power supplies and high frequency DC to DC converters.

Packaged in SMC this device is intended for use in DC/DC chargers for automotive applications.



Table 1. Device summary

I <sub>F(AV)</sub>	3 A
V <sub>RRM</sub>	60 V
T <sub>j (max)</sub>	150 °C
V <sub>F (max)</sub>	0.65 V

**Characteristics** STPS3L60-Y

#### **Characteristics**

Table 2. Absolute ratings (limiting values)

Symbol	Paramet	Value	Unit	
V <sub>RRM</sub>	Repetitive peak reverse voltage		60	V
I <sub>F(RMS)</sub>	Forward rms current		10	Α
I <sub>F(AV)</sub>	Average forward current	$T_C = 100  ^{\circ}C  \delta = 0.5$	3	Α
I <sub>FSM</sub>	Surge non repetitive forward current	t <sub>p</sub> = 10 ms Sinusoidal	75	Α
I <sub>RRM</sub>	Repetitive peak reverse current	t <sub>p</sub> = 2 μs square F=1 kHz	1	Α
P <sub>ARM</sub>	Repetitive peak avalanche power $t_p = 1 \mu s T_j = 25  ^{\circ}C$		1600	W
T <sub>stg</sub>	Storage temperature range	-65 to +175	°C	
Tj	Operating junction temperature range <sup>(1)</sup>		-40 to +150	°C
dV/dt	Critical rate of rise reverse voltage		10000	V/µs

<sup>1.</sup>  $\frac{dPtot}{dT_j} < \frac{1}{Rth(j-a)}$  condition to avoid thermal runaway for a diode on its own heatsink

Table 3. Thermal resistances

Symbol	Parameter	Value	Unit
R <sub>th (j-l)</sub>	Junction to leads	20	° C/W

Table 4. Static electrical characteristics

Symbol	Parameter	Tests conditions		Min.	Тур.	Max.	Unit
I <sub>R</sub> <sup>(1)</sup> Reverse leakage current	T <sub>j</sub> = 25 °C	V <sub>R</sub> = V <sub>RRM</sub>			55	μΑ	
'R`´	Reverse leakage current	T <sub>j</sub> = 125 °C	VR = VRRM		10	15	mA
	V <sub>F</sub> <sup>(1)</sup> Forward voltage drop	T <sub>j</sub> = 25 °C	I <sub>F</sub> = 3 A			0.7	
V <sub>E</sub> <sup>(1)</sup>		T <sub>j</sub> = 125 °C	I <sub>F</sub> = 3 A		0.56	0.65	V
V <sub>F</sub> · · · · · · · · · · · · · · · · · · ·	T <sub>j</sub> = 25 °C	I <sub>F</sub> = 6 A			0.94	V	
	T <sub>j</sub> = 125 °C	I <sub>F</sub> = 6 A		0.67	0.76		

<sup>1.</sup> Pulse test:  $t_p = 380 \mu s$ ,  $\delta < 2\%$ 

To evaluate the conduction losses use the following equation: P = 0.54 x  $I_{F(AV)}$  + 0.037x  $I_{F}^{\,2}_{(RMS)}$ 

$$P = 0.54 \times I_{E(AV)} + 0.037 \times I_{E(BMS)}^{2}$$

STPS3L60-Y Characteristics

Figure 1. Average forward power dissipation Figure 2. Average forward current versus versus average forward current ambient temperature ( $\delta$  = 0.5)

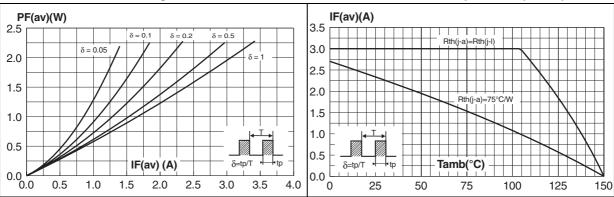


Figure 3. Normalized avalanche power derating versus pulse duration

Figure 4. Normalized avalanche power derating versus junction temperature

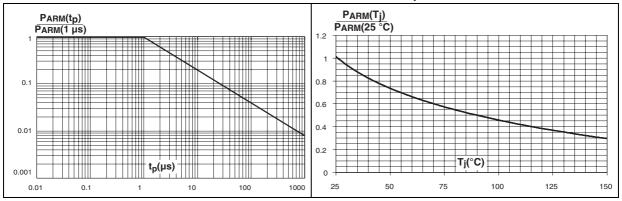
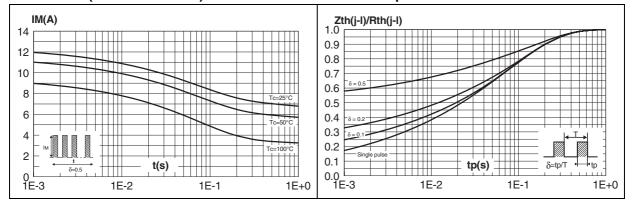


Figure 5. Non repetitive surge peak forward current versus overload duration (maximum values)

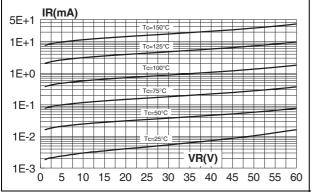
Figure 6. Relative variation of thermal impedance junction to lead versus pulse duration



Characteristics STPS3L60-Y

Figure 7. Reverse leakage current versus reverse voltage applied (typical values)

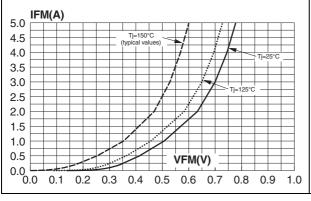
Figure 8. Junction capacitance versus reverse voltage applied (typical values)



C(pF)
500
200
100
50
VR(V)
10
100
100

Figure 9. Forward voltage drop versus forward current (low level, maximum values)

Figure 10. Forward voltage drop versus forward current (high level, maximum values)



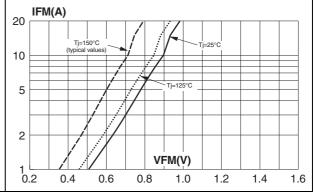
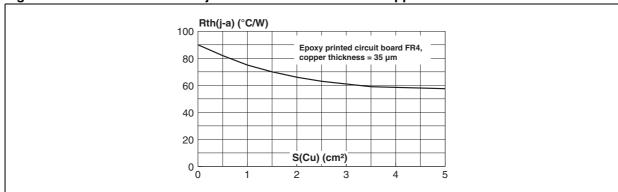


Figure 11. Thermal resistance junction to ambient versus copper surface under each lead



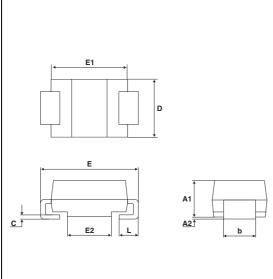
STPS3L60-Y Package information

### 2 Package information

- Epoxy meets UL94,V0
- Lead-free package

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: <a href="https://www.st.com">www.st.com</a>. ECOPACK<sup>®</sup> is an ST trademark.

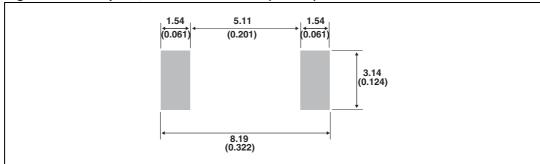
Table 5. SMC Dimensions



	Dimensions			
Ref.	Millimeters		Inc	hes
	Min.	Min. Max.		Max.
A1	1.90	2.45	0.075	0.096
A2	0.05	0.20	0.002	0.008
b <sup>(1)</sup>	2.90	3.20	0.114	0.126
c <sup>(1)</sup>	0.15	0.40	0.006	0.016
D	5.55	6.25	0.218	0.246
Е	7.75	8.15	0.305	0.321
E1	6.60	7.15	0.260	0.281
E2	4.40	4.70	0.173	0.185
L	0.75	1.50	0.030	0.059

<sup>1.</sup> Dimensions b and c apply to plated leads

Figure 12. Footprint, dimensions in mm (inches)



Ordering information STPS3L60-Y

# **3** Ordering information

 Table 6.
 Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
STPS3L60SY	S36Y	SMC	0.24 g	2500 Tape and	

## 4 Revision history

Table 7. Document revision history

Date	Revision	Changes
15-Sep-2011	1	Initial release.

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